

FAIRCHILD

A Schlumberger Company

IRF140-143/IRF540-543 T-39-13

N-Channel Power MOSFETs, 27 A, 60-100 V

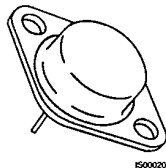
Power And Discrete Division

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high power, high speed applications, such as switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers and high energy pulse circuits.

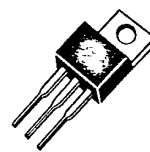
- Low $R_{DS(on)}$
- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $V_{DS(on)}$, Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

TO-204AE



IRF140
IRF141
IRF142
IRF143

TO-220AB



IRF540
IRF541
IRF542
IRF543

Product Summary

Part Number	V_{DSS}	$R_{DS(on)}$	I_D at $T_C = 25^\circ\text{C}$	I_D at $T_C = 100^\circ\text{C}$	Case Style
IRF140	100 V	0.085 Ω	27 A	17 A	TO-204AE
IRF141	60 V	0.085 Ω	27 A	17 A	
IRF142	100 V	0.11 Ω	24 A	15 A	
IRF143	60 V	0.11 Ω	24 A	15 A	
IRF540	100 V	0.085 Ω	27 A	17 A	TO-220AB
IRF541	60 V	0.085 Ω	27 A	17 A	
IRF542	100 V	0.11 Ω	24 A	15 A	
IRF543	60 V	0.11 Ω	24 A	15 A	

Notes

For information concerning connection diagram and package outline, refer to Section 7.

IRF140-143/IRF540-543

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Maximum Ratings

Symbol	Characteristic	Rating IRF140/142 IRF540/542	Rating IRF141/143 IRF541/543	Unit
V _{DSS}	Drain to Source Voltage ¹	100	60	V
V _{DGR}	Drain to Gate Voltage ¹ R _{GS} = 20 kΩ	100	60	V
V _{GS}	Gate to Source Voltage	± 20	± 20	V
T _J , T _{stg}	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	°C

Maximum Thermal Characteristics

		IRF140-143	IRF540-543	
R _{θJC}	Thermal Resistance, Junction to Case	1.0	1.0	°C/W
P _D	Total Power Dissipation at T _C = 25°C	125	125	W
I _{DM}	Pulsed Drain Current ²	108	108	A

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Off Characteristics					
V _{(BR)DSS}	Drain Source Breakdown Voltage ¹			V	V _{GS} = 0 V, I _D = 250 μA
	IRF140/142/540/542	100			
	IRF141/143/541/543	60			
I _{DSS}	Zero Gate Voltage Drain Current		250	μA	V _{DS} = Rated V _{DSS} , V _{GS} = 0 V
			1000	μA	V _{DS} = 0.8 × Rated V _{DSS} , V _{GS} = 0 V, T _C = 125°C
I _{GSS}	Gate-Body Leakage Current		± 100	nA	V _{GS} = ± 20 V, V _{DS} = 0 V
	IRF140-143		± 500		
	IRF540-543		± 500		
On Characteristics					
V _{GS(th)}	Gate Threshold Voltage	2.0	4.0	V	I _D = 250 μA, V _{DS} = V _{GS}
R _{DS(on)}	Static Drain-Source On-Resistance ²			Ω	V _{GS} = 10 V, I _D = 15 A
	IRF140/141/540/541		0.085		
	IRF142/143/542/543		0.11		
g _{fs}	Forward Transconductance	6.0		S (Ω)	V _{DS} = 10 V, I _D = 15 A

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Electrical Characteristics (Cont.) ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Dynamic Characteristics					
C _{iss}	Input Capacitance		1600	pF	V _{DS} = 25 V, V _{GS} = 0 V f = 1.0 MHz
C _{oss}	Output Capacitance		800	pF	
C _{rss}	Reverse Transfer Capacitance		300	pF	
Switching Characteristics (T _C = 25°C, Figures 1, 2,) ³					
t _{d(on)}	Turn-On Delay Time		30	ns	V _{DD} = 45 V, I _D = 15 A V _{GS} = 10 V, R _{GEN} = 4.7 Ω R _{GS} = 4.7 Ω
t _r	Rise Time		60	ns	
t _{d(off)}	Turn-Off Delay Time		80	ns	
t _f	Fall Time		30	ns	
t _{d(on)}	Turn-On Delay Time		60	ns	V _{DD} = 25 V, I _D = 15 A V _{GS} = 10 V, R _{GEN} = 50 Ω R _{GS} = 50 Ω
t _r	Rise Time		450	ns	
t _{d(off)}	Turn-Off Delay Time		150	ns	
t _f	Fall Time		200	ns	
Q _g	Total Gate Charge		60	nC	V _{GS} = 10 V, I _D = 34 A V _{DD} = 35 V
Symbol	Characteristic	Typ	Max	Unit	Test Conditions
Source-Drain Diode Characteristics					
V _{SD}	Diode Forward Voltage				
	IRF140/141/540/541	2.0	2.5	V	I _S = 27 A; V _{GS} = 0 V
	IRF142/143/542/543	2.0	2.3	V	I _S = 24 A; V _{GS} = 0 V
t _{rr}	Reverse Recovery Time	300		ns	I _S = 4.0 A; dI _S /dt = 25 A/μS

Notes

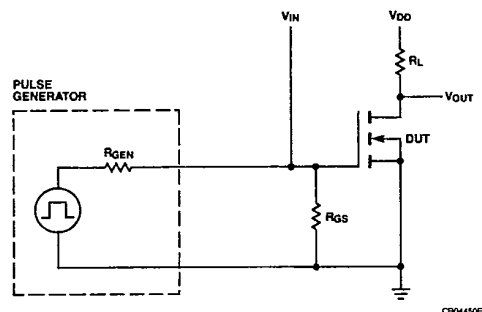
- $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$
- Pulse width limited by T_J
- Switching time measurements performed on LEM TR-58 test equipment.

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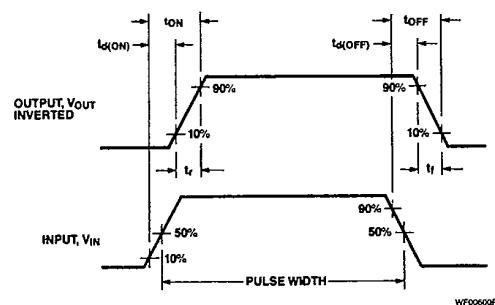
Typical Electrical Characteristics

Figure 1 Switching Test Circuit



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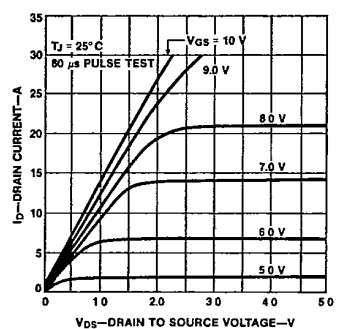
Figure 2 Switching Waveforms



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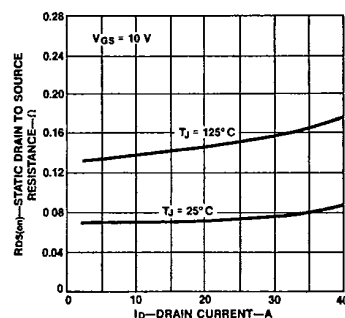
Typical Performance Curves

Figure 3 Output Characteristics



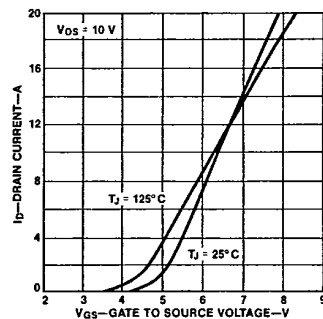
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Figure 4 Static Drain to Source Resistance vs Drain Current



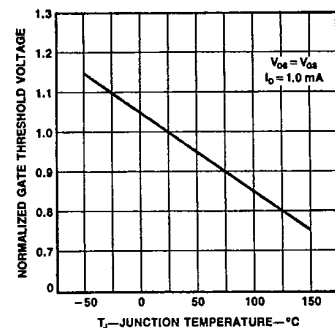
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Figure 5 Transfer Characteristics



PC10060F

Figure 6 Temperature Variation of Gate to Source Threshold Voltage



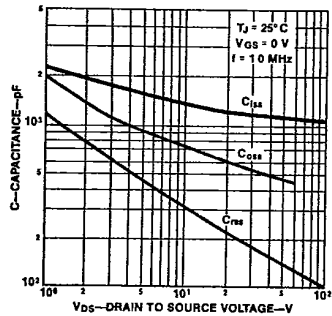
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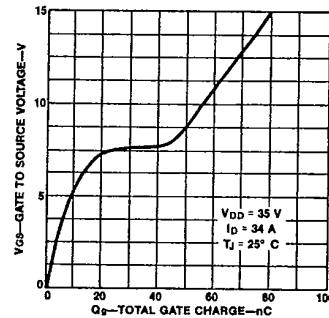
Typical Performance Curves (Cont.)

Figure 7 Capacitance vs Drain to Source Voltage



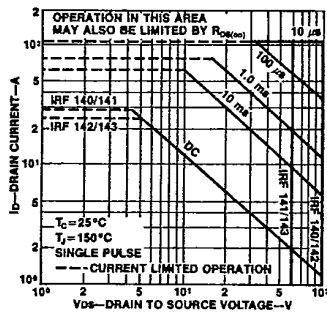
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Figure 8 Gate to Source Voltage vs Total Gate Charge



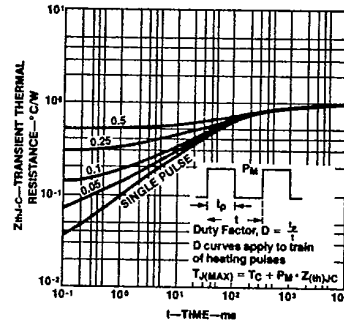
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Figure 9 Forward Biased Safe Operating Area



PC10090F

Figure 10 Transient Thermal Resistance vs Time



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